

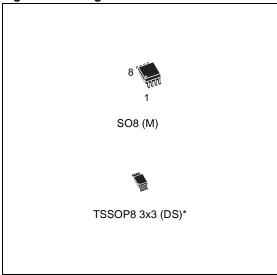
# STM690, STM704, STM795 STM802, STM804, STM805, STM806

# 3V Supervisor with Battery Switchover

### **FEATURES SUMMARY**

- RST OR RST OUTPUTS
- NVRAM SUPERVISOR FOR EXTERNAL LPSRAM
- CHIP-ENABLE GATING (STM795 only) FOR EXTERNAL LPSRAM (7ns max PROP DELAY)
- MANUAL (PUSH-BUTTON) RESET INPUT
- 200ms (TYP) t<sub>rec</sub>
- WATCHDOG TIMER 1.6sec (TYP)
- AUTOMATIC BATTERY SWITCHOVER
- LOW BATTERY SUPPLY CURRENT 0.4μA (TYP)
- POWER-FAIL COMPARATOR (PFI/PFO)
- LOW SUPPLY CURRENT 40µA (TYP)
- GUARANTEED RST (RST) ASSERTION DOWN TO V<sub>CC</sub> = 1.0V
- OPERATING TEMPERATURE:
   -40°C to 85°C (Industrial Grade)

Figure 1. Packages



**Table 1. Device Options** 

| Table 11 Device options |                   |                                   |                        |                       |                        |                               |                           |  |  |  |
|-------------------------|-------------------|-----------------------------------|------------------------|-----------------------|------------------------|-------------------------------|---------------------------|--|--|--|
|                         | Watchdog<br>Input | Active-<br>Low RST <sup>(1)</sup> | Active-<br>High<br>RST | Manual<br>Reset Input | Battery<br>Switch-over | Power-fail<br>Compar-<br>ator | Chip-<br>Enable<br>Gating |  |  |  |
| STM690T/S/R             | <b>'</b>          | ~                                 |                        |                       | ~                      | ~                             |                           |  |  |  |
| STM704T/S/R             |                   | ~                                 |                        | ~                     | ~                      | ~                             |                           |  |  |  |
| STM795T/S/R             |                   | <b>✓</b> (2)                      |                        |                       | ~                      |                               | ~                         |  |  |  |
| STM802T/S/R             | <b>~</b>          | ~                                 |                        |                       | ~                      | ~                             |                           |  |  |  |
| STM804T/S/R             | <b>V</b>          |                                   | <b>✓</b> (2)           |                       | ~                      | ~                             |                           |  |  |  |
| STM805T/S/R             | <b>V</b>          |                                   | <b>✓</b> (2)           |                       | ~                      | ~                             |                           |  |  |  |
| STM806T/S/R             |                   | ~                                 |                        | ~                     | ~                      | ~                             |                           |  |  |  |

Note: 1. All RST outputs push-pull (unless otherwise noted)

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Open drain output.

<sup>\*</sup> Contact local ST sales office for availability.

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## STM690/704/795/802/804/805/806

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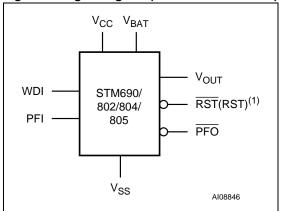
#### SUMMARY DESCRIPTION

The STM690/704/795/802/804/805/806 Supervisors are self-contained devices which provide microprocessor supervisory functions with the ability to non-volatize and write-protect external LPSRAM. A precision voltage reference and comparator monitors the  $V_{CC}$  input for an out-of-tolerance condition. When an invalid  $V_{CC}$  condition occurs, the reset output ( $\overline{RST}$ ) is forced low (or high in the case of RST). These devices also offer

a watchdog timer (except for STM704/795/806) as well as a power-fail comparator (except for STM795) to provide the system with an early warning of impending power failure.

These devices are available in a standard 8-pin SOIC package or a space-saving 8-pin TSSOP package.

Figure 2. Logic Diagram (STM690/802/804/805)



Note: 1. For STM804/805, reset output is active-high and open drain.

Figure 3. Logic Diagram (STM704/806)

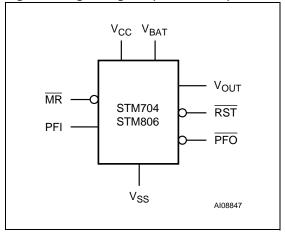


Figure 4. Logic Diagram (STM795)

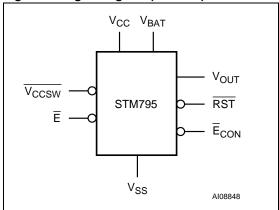


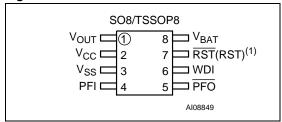
Table 2. Signal Names

| Table 2. Signal Names |                                |  |  |  |
|-----------------------|--------------------------------|--|--|--|
| MR                    | Push-button Reset Input        |  |  |  |
| WDI                   | Watchdog Input                 |  |  |  |
| RST                   | Active-Low Reset Output        |  |  |  |
| RST <sup>(1)</sup>    | Active-High Reset Output       |  |  |  |
| Ē <sup>(2)</sup>      | Chip Enable Input              |  |  |  |
| E <sub>CON</sub> (2)  | Conditioned Chip Enable Output |  |  |  |
| Vccsw <sup>(2)</sup>  | V <sub>CC</sub> Switch Output  |  |  |  |
| V <sub>OUT</sub>      | Supply Voltage Output          |  |  |  |
| V <sub>CC</sub>       | Supply Voltage                 |  |  |  |
| V <sub>BAT</sub>      | Back-up Supply Voltage         |  |  |  |
| PFI                   | Power-fail Input               |  |  |  |
| PFO                   | Power-fail Output              |  |  |  |
| V <sub>SS</sub>       | Ground                         |  |  |  |

Note: 1. Open drain for STM804/805 only.

2. STM795

Figure 5. STM690/802/804/805 Connections



Note: 1. For STM804/805, reset output is active-high and open drain.

Figure 6. STM704/806 Connections

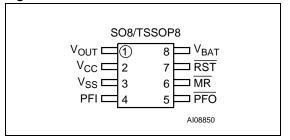
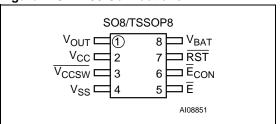


Figure 7. STM795 Connections



#### **Pin Descriptions**

MR. A logic low on /MR asserts the reset output. Reset remains asserted as long as MR is low and for t<sub>rec</sub> after MR returns high. This active-low input has an internal pull-up. It can be driven from a TTL or CMOS logic line, or shorted to ground with a switch. Leave open if unused.

**WDI.** If WDI remains high or low for 1.6sec, the internal watchdog timer runs out and reset is triggered. The internal watchdog timer clears while reset is asserted or when WDI sees a rising or falling edge.

The watchdog function cannot be disabled by allowing the WDI pin to float.

 $\overline{\textbf{RST.}}$  Pulses low for  $t_{\text{rec}}$  when triggered, and stays low whenever  $V_{CC}$  is below the reset threshold or when  $\overline{\text{MR}}$  is a logic low. It remains low for  $t_{\text{rec}}$  after either  $V_{CC}$  rises above the reset threshold, the watchdog triggers a reset, or  $\overline{\text{MR}}$  goes from low to high.

**RST (Open Drain).** Pulses high for  $t_{rec}$  when triggered, and stays high whenever  $V_{CC}$  is above the reset threshold or when  $\overline{MR}$  is a logic high. It remains high for  $t_{rec}$  after either  $V_{CC}$  falls below the reset threshold, the watchdog triggers a reset, or  $\overline{MR}$  goes from high to low.

**PFI.** When PFI is less than  $V_{PFI}$  or when  $V_{CC}$  falls below  $V_{SW}$  (2.4V),  $\overline{PFO}$  goes low; otherwise,  $\overline{PFO}$  remains high. Connect to ground if unused.

 $\overline{\text{PFO}}$ . When PFI is less than V<sub>PFI</sub>, or V<sub>CC</sub> falls below V<sub>SW</sub>,  $\overline{\text{PFO}}$  goes low; otherwise,  $\overline{\text{PFO}}$  remains high. Leave open if unused.

**Vout.** When  $V_{CC}$  is above the switchover voltage (V<sub>SO</sub>), V<sub>OUT</sub> is connected to V<sub>CC</sub> through a P-channel MOSFET switch. When V<sub>CC</sub> falls below V<sub>SO</sub>, V<sub>BAT</sub> connects to V<sub>OUT</sub>. Connect to V<sub>CC</sub> if no battery is used.

Vccsw. When V<sub>OUT</sub> switches to battery, Vccsw is high. When V<sub>OUT</sub> switches back to V<sub>CC</sub>, Vccsw is low. It can be used to drive gate of external PMOS transistor for I<sub>OUT</sub> requirements exceeding 75mA.

**E.** The input to the chip-enable gating circuit. Connect to ground if unused.

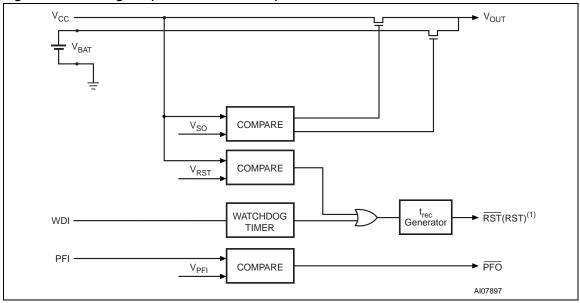
 $\overline{\mathbf{E}_{\text{CON}}}$ .  $\overline{\mathbf{E}}_{\text{CON}}$  goes low only when  $\overline{\mathbf{E}}$  is low and reset is not asserted. If  $\overline{\mathbf{E}}_{\text{CON}}$  is low when reset is asserted,  $\overline{\mathbf{E}}_{\text{CON}}$  will remain low for 15µs or until  $\overline{\mathbf{E}}$  goes high, whichever occurs first. In the disabled mode,  $\overline{\mathbf{E}}_{\text{CON}}$  is pulled up to  $V_{\text{OUT}}$ .

 $V_{BAT}$ . When  $V_{CC}$  falls below  $V_{SO}$ ,  $V_{OUT}$  switches from  $V_{CC}$  to  $V_{BAT}$ . When  $V_{CC}$  rises above  $V_{SO}$  + hysteresis,  $V_{OUT}$  reconnects to  $V_{CC}$ .  $V_{BAT}$  may exceed  $V_{CC}$ . Connect to  $V_{CC}$  if no battery is used.

**Table 3. Pin Description** 

|        | P                | in               |                  | Name            | Function                          |
|--------|------------------|------------------|------------------|-----------------|-----------------------------------|
| STM795 | STM690<br>STM802 | STM704<br>STM806 | STM804<br>STM805 |                 |                                   |
| -      | _                | 6                | -                | MR              | Push-button Reset Input           |
| -      | 6                | _                | 6                | WDI             | Watchdog Input                    |
| 7      | 7                | 7                | -                | RST             | Active-Low Reset Output           |
| _      | _                | _                | 7                | RST             | Active-High Reset Output          |
| _      | 4                | 4                | 4                | PFI             | PFI Power-fail Input              |
| -      | 5                | 5                | 5                | PFO             | PFO Power-fail Output             |
| 1      | 1                | 1                | 1                | Vout            | Supply Output for External LPSRAM |
| 2      | 2                | 2                | 2                | Vcc             | Supply Voltage                    |
| 3      | _                | -                | -                | Vccsw           | V <sub>CC</sub> Switch Output     |
| 4      | 3                | 3                | 3                | V <sub>SS</sub> | Ground                            |
| 5      |                  |                  | -                | Ē               | Chip Enable Input                 |
| 6      | _                | _                | _                | Econ            | Conditioned Chip Enable Output    |
| 8      | 8                | 8                | 8                | $V_{BAT}$       | Backup-Battery Input              |

Figure 8. Block Diagram (STM690/802/804/805)



Note: 1. For STM804/805, reset output is active-high and open drain.

Figure 9. Block Diagram (STM704/806)

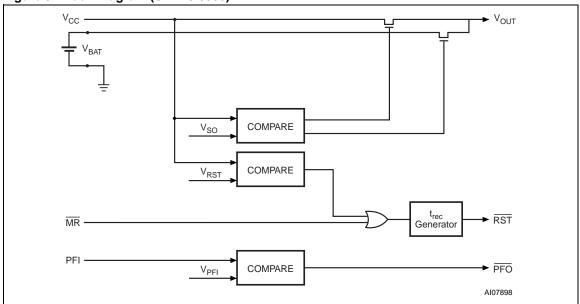


Figure 10. Block Diagram (STM795)

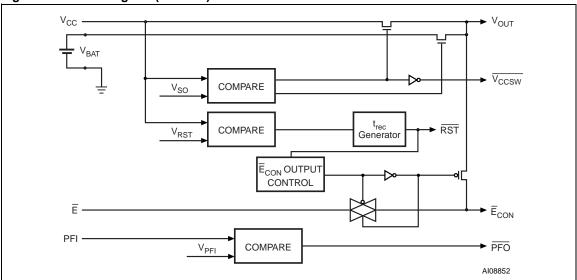
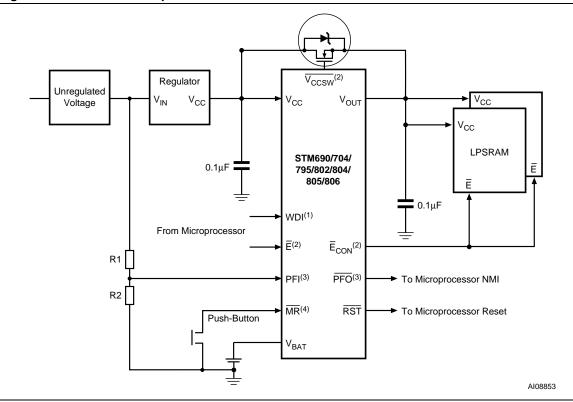


Figure 11. Hardware Hookup



Note: 1. For STM690/802/804/805.

- For STM795 only.
   Not available on STM795.
- 4. For STM704/806.

#### **OPERATION**

#### **Reset Output**

The STM690/704/795/802/804/805/806 Supervisor asserts a reset signal to the MCU whenever V<sub>CC</sub> goes below the reset threshold (V<sub>RST</sub>), a watchdog time-out occurs, or when the Push-button Reset Input ( $\overline{MR}$ ) is taken low.  $\overline{RST}$  is guaranteed to be a logic low (logic high for STM804/805) for 0V < V<sub>CC</sub> < V<sub>RST</sub> if V<sub>BAT</sub> is greater than 1V. Without a back-up battery,  $\overline{RST}$  is guaranteed valid down to V<sub>CC</sub> =1V.

During power-up, once  $V_{CC}$  exceeds the reset threshold an internal timer keeps  $\overline{RST}$  low fo<u>r the</u> reset time-out period,  $t_{rec}$ . After this interval  $\overline{RST}$  returns high.

If  $V_{CC}$  drops below the reset threshold,  $\overline{RST}$  goes low. Each time  $\overline{RST}$  is asserted, it stays low for at least the reset time-out period ( $t_{rec}$ ). Any time  $V_{CC}$  goes below the reset threshold the internal timer clears. The reset timer starts when  $V_{CC}$  returns above the reset threshold.

#### Push-button Reset Input (STM704/806)

A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low, and for  $t_{rec}$  (see Figure 36., page 22) after it returns high. The  $\overline{MR}$  input has an internal 40k $\Omega$  pull-up resistor, allowing it to be left open if not used. This input can be driven with TTL/CMOS-logic levels or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to GND to create a manual reset function; external debounce circuitry is not required. If  $\overline{MR}$  is driven from long cables or the device is used in a noisy environment, connect a 0.1µF capacitor from  $\overline{MR}$  to GND to provide additional noise immunity.  $\overline{MR}$  may float, or be tied to  $V_{CC}$  when not used.

# Watchdog Input (NOT available on STM704/795/806)

The watchdog timer can be used to detect an out-of-control MCU. If the MCU does not toggle the Watchdog Input (WDI) within t<sub>WD</sub> (1.6sec typ), the reset is asserted. The internal watchdog timer is cleared by either:

- 1. a reset pulse, or
- by toggling WDI (high-to-low or low-to-high), which can detect pulses as short as 50ns. If WDI is tied high or low, a reset pulse is triggered every 1.8sec (t<sub>WD</sub> + t<sub>rec</sub>).

The timer remains cleared and does not count for as long as reset is asserted. As soon as reset is released, the timer starts counting (see Figure 37., page 23).

**Note:** Input frequency greater than 20ns (50MHz) will be filtered.

#### **Back-up Battery Switchover**

In the event of a power failure, it may be necessary to preserve the contents of external SRAM through  $V_{OUT}$ . With a backup battery installed with voltage  $V_{BAT}$ , the devices automatically switch the SRAM to the back-up supply when  $V_{CC}$  falls.

**Note:** If back-up battery is not used, connect both  $V_{BAT}$  and  $V_{OUT}$  to  $V_{CC}$ .

This family of Supervisors does not always connect  $V_{BAT}$  to  $V_{OUT}$  when  $V_{BAT}$  is greater than  $V_{CC}$ .  $V_{BAT}$  connects to  $V_{OUT}$  (through a  $100\Omega$  switch) when  $V_{CC}$  is below  $V_{SW}$  (2.4V) or  $V_{BAT}$  (whichever is lower). This is done to allow the back-up battery (e.g., a 3.6V lithium cell) to have a higher voltage than  $V_{CC}$ .

Assuming that V<sub>BAT</sub> > 2.0V, switchover at V<sub>SO</sub> ensures that battery back-up mode is entered before V<sub>OUT</sub> gets too close to the 2.0V minimum required to reliably retain data in most external SRAMs. When V<sub>CC</sub> recovers, hysteresis is used to avoid oscillation around the V<sub>SO</sub> point. V<sub>OUT</sub> is connected to V<sub>CC</sub> through a 3 $\Omega$  PMOS power switch.

**Note:** The back-up battery may be removed while  $V_{CC}$  is valid, assuming  $V_{BAT}$  is adequately decoupled (0.1 $\mu$ F typ), without danger of triggering a reset.

Table 4. I/O Status in Battery Back-up

| Pin              | Status                                                |
|------------------|-------------------------------------------------------|
| Vout             | Connected to V <sub>BAT</sub> through internal switch |
| V <sub>CC</sub>  | Disconnected from V <sub>OUT</sub>                    |
| PFI              | Disabled                                              |
| PFO              | Logic Low                                             |
| Ē                | High impedance                                        |
| Ē <sub>CON</sub> | Logic High                                            |
| WDI              | Watchdog timer is disabled                            |
| MR               | Disabled                                              |
| RST              | Logic Low                                             |
| RST              | Logic High                                            |
| V <sub>BAT</sub> | Connected to V <sub>OUT</sub>                         |
| Vccsw            | Logic High (STM795)                                   |

### Chip-Enable Gating (STM795 only)

Internal gating of the chip enable ( $\overline{E}$ ) signal prevents erroneous data from corrupting the external CMOS RAM in the event of an undervoltage condition. The STM795 uses a series transmission gate from  $\overline{E}$  to  $\overline{E}_{CON}$  (see Figure 12). During normal operation (reset not asserted), the  $\overline{E}$  transmission gate is enabled and passes all  $\overline{E}$  transitions. When reset is asserted, this path becomes disabled, preventing erroneous data from corrupting the CMOS RAM. The short  $\overline{E}$  propagation delay from  $\overline{E}$  to  $\overline{E}_{CON}$  enables the STM795 to be used with most  $\mu$ Ps. If  $\overline{E}$  is low when reset asserts,  $\overline{E}_{CON}$  remains low for typically 10 $\mu$ s to permit the current WRITE cycle to complete.

#### Chip Enable Input (STM795 only)

The chip-enable transmission gate is disabled and  $\overline{E}$  is high impedance (disabled mode) while reset is asserted. During a power-down sequence when  $V_{CC}$  passes the reset threshold, the chip-enable transmission gate disables and  $\overline{E}$  immediately becomes high impedance if the voltage at  $\overline{E}$  is high. If  $\overline{E}$  is low when reset asserts, the chip-enable transmission gate will disable 10µs after reset asserts (see Figure 13). This permits the current WRITE cycle to complete during power-down.

Any time a reset is generated, the chip-enable transmission gate remains disabled and  $\overline{E}$  remains high impedance (regardless of E activity) for the first half of the reset time-out period (t<sub>rec</sub>/2). When the chip enable transmission gate is enabled, the impedance of  $\overline{E}$  appears as a  $40\Omega$  resistor in series with the load at  $\overline{E}_{CON}$ . The propagation delay through the chip-enable transmission gate depends on V<sub>CC</sub>, the source impedance of the drive connected to  $\overline{E}$ , and the loading on  $\overline{E}_{CON}$ . The chip enable propagation delay is production tested from the 50% point on  $\overline{E}$  to the 50% point on  $\overline{E}_{CON}$ using a  $50\Omega$  driver and a 50pF load capacitance (see Figure 35., page 22). For minimum propagation delay, minimize the capacitive load at  $\overline{E}_{CON}$ and use a low-output impedance driver.

#### **Chip Enable Output (STM795 only)**

When the chip-enable transmission gate is enabled, the impedance of  $\overline{E}_{CON}$  is equivalent to a  $40\Omega$  resistor in series with the source driving  $\overline{E}.$  In the disabled mode, the transmission gate is off and an active pull-up connects  $\overline{E}_{CON}$  to  $V_{OUT}$  (see Figure 12). This pull-up turns off when the transmission gate is enabled.

Figure 12. Chip-Enable Gating

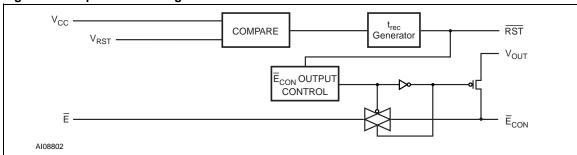
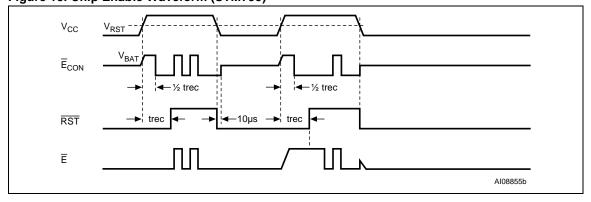


Figure 13. Chip Enable Waveform (STM795)



#### Power-fail Input/Output (NOT available on STM795)

The Power-fail Input (PFI) is compared to an internal reference voltage (independent from the  $V_{RST}$  comparator). If PFI is less than the power-fail threshold ( $V_{PFI}$ ), the Power-Fail Output ( $\overline{PFO}$ ) will go low. This function is intended for use as an undervoltage detector to signal a failing power supply. Typically PFI is connected through an external voltage divider (see Figure 11., page 8) to either the unregulated DC input (if it is available) or the regulated output of the  $V_{CC}$  regulator. The voltage divider can be set up such that the voltage at PFI falls below  $V_{PFI}$  several milliseconds before the regulated  $V_{CC}$  input to the STM690/704/795/802/804/805/806 or the microprocessor drops below the minimum operating voltage.

During battery back-up, the power-fail comparator is turned off and PFO goes (or remains) low (see

Figure 14., page 11). This occurs after  $V_{CC}$  drops below  $V_{SW}$  (2.4V). When power returns, the power-fail comparator is enabled and  $\overline{PFO}$  follows PFI. If the comparator is unused, PFI should be connected to  $V_{SS}$  and  $\overline{PFO}$  left unconnected.  $\overline{PFO}$  may be connected to  $\overline{MR}$  on the STM704/806 so that a low voltage on PFI will generate a reset output.

#### **Applications Information**

These Supervisor circuits are not short-circuit protected. Shorting  $V_{OUT}$  to ground - excluding power-up transients such as charging a decoupling capacitor - destroys the device. Decouple both  $V_{CC}$  and  $V_{BAT}$  pins to ground by placing  $0.1\mu F$  capacitors as close to the device as possible.

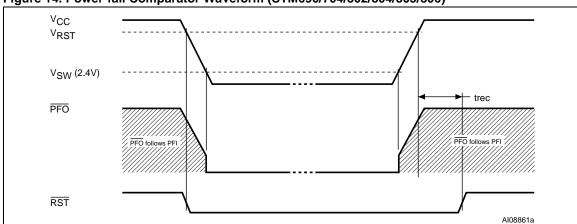
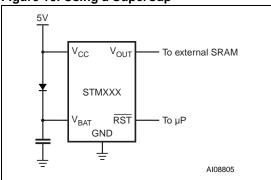


Figure 14. Power-fail Comparator Waveform (STM690/704/802/804/805/806)

#### Using a SuperCap™ as a Backup Power Source

SuperCaps<sup>TM</sup> are capacitors with extremely high capacitance values (e.g., order of 0.47F) for their size. Figure 15 shows how to use a SuperCap as a back-up power source. The SuperCap may be connected through a diode to the  $V_{CC}$  supply. Since  $V_{BAT}$  can exceed  $V_{CC}$  while  $V_{CC}$  is above the reset threshold, there are no special precautions when using these supervisors with a SuperCap.

Figure 15. Using a SuperCap™



#### **Negative-Going V<sub>CC</sub> Transients**

The STM690/704/795/802/804/805/806 Supervisors are relatively immune to negative-going V<sub>CC</sub> transients (glitches). Figure 32., page 20 was generated using a negative pulse applied to V<sub>CC</sub>, starting at V<sub>RST</sub> + 0.3V and ending below the reset threshold by the magnitude indicated (comparator overdrive). The graph indicates the maximum pulse width a negative V<sub>CC</sub> transient can have without causing a reset pulse. As the magnitude of the transient increases (further below the threshold), the maximum allowable pulse width decreases. Any combination of duration and overdrive which lies under the curve will NOT generate a reset signal. Typically, a V<sub>CC</sub> transient that goes 100mV below the reset threshold and lasts 40µs or less will not cause a reset pulse. A 0.1µF bypass capacitor mounted as close as possible to the V<sub>CC</sub> pin provides additional transient immunity.

## TYPICAL OPERATING CHARACTERISTICS

**Note:** Typical values are at  $T_A = 25$ °C.

Figure 16. V<sub>BAT</sub>-to-V<sub>OUT</sub> On-Resistance vs. Temperature

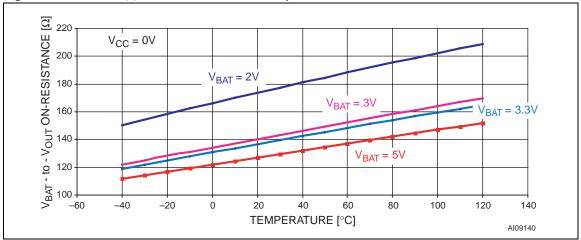


Figure 17. Supply Current vs. Temperature (no load)

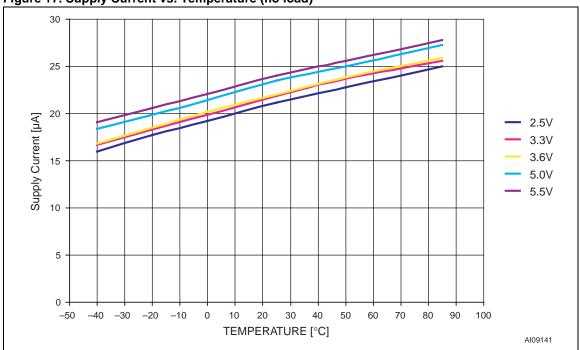


Figure 18. V<sub>PFI</sub> Threshold vs. Temperature

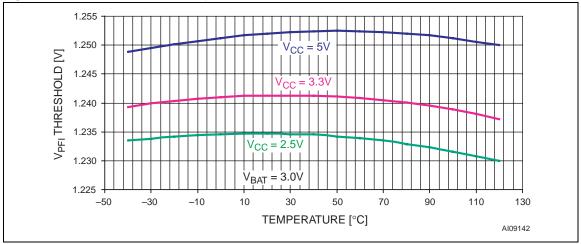


Figure 19. Reset Comparator Propagation Delay vs. Temperature

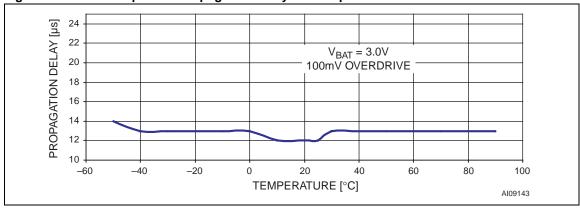
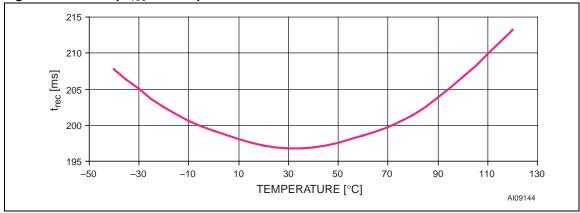


Figure 20. Power-up trec vs. Temperature





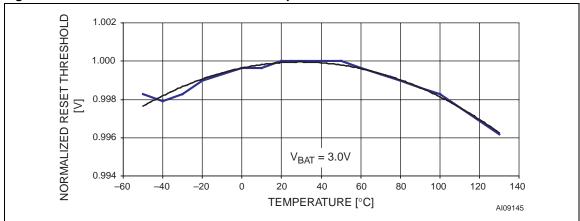


Figure 22. Watchdog Time-out Period vs. Temperature

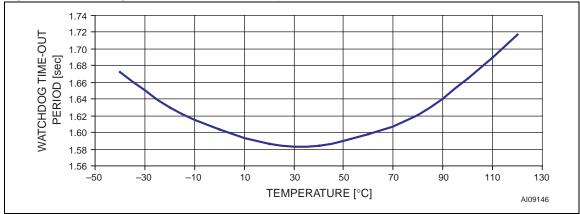


Figure 23.  $\overline{E}$  to  $\overline{E}_{CON}$  On-Resistance vs. Temperature

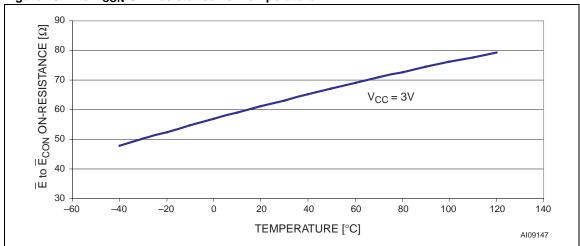


Figure 24. PFI to PFO Propagation Delay vs. Temperature

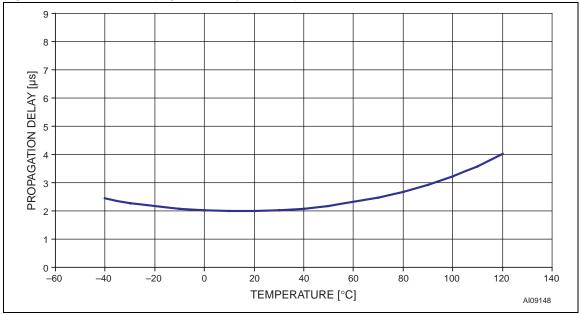
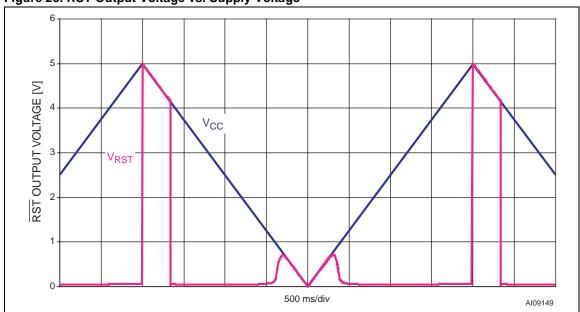
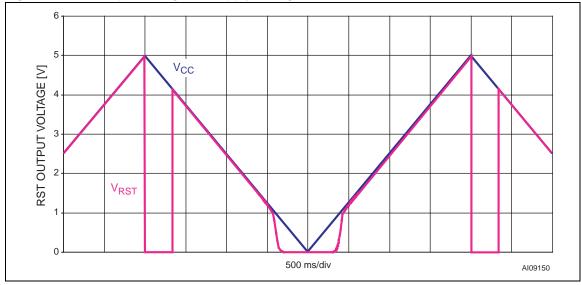


Figure 25. RST Output Voltage vs. Supply Voltage







## Figure 27. RST Response Time (Assertion)





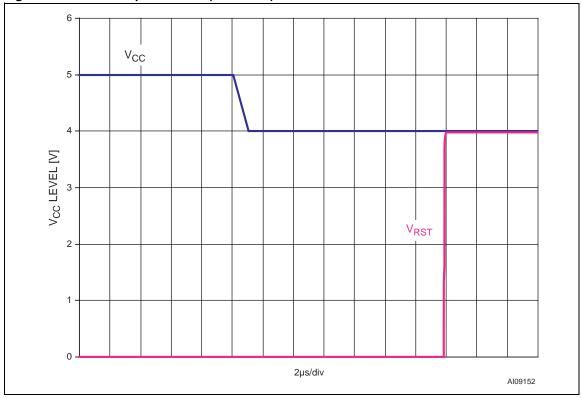
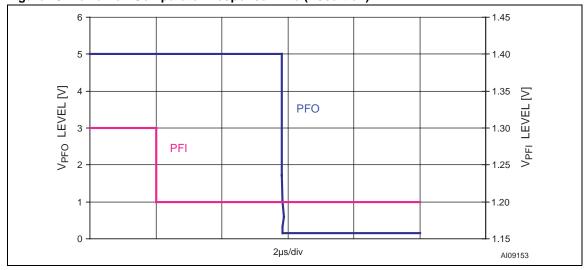


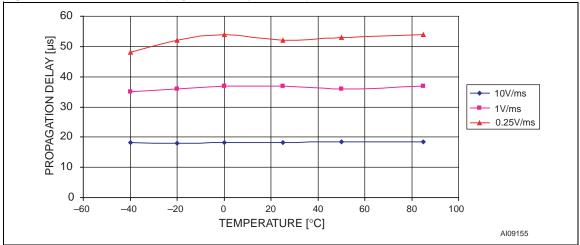
Figure 29. Power-fail Comparator Response Time (Assertion)



1.45 5 1.40 V<sub>PFO</sub> LEVEL (V) 1.35 PFO PFI 1.20 1.15 2 µs/div AI09154

Figure 30. Power-fail Comparator Response Time (De-Assertion)



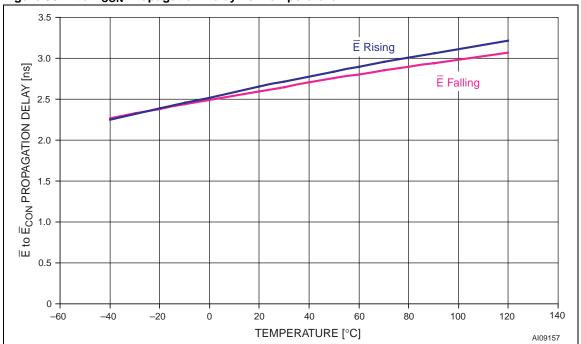


47/ 19/31

250 200 1000 10000 RESET COMPARATOR OVERDRIVE, V<sub>RST</sub> – V<sub>CC</sub> [mV]

Figure 32. Maximum Transient Duration vs. Reset Threshold Overdrive





#### **MAXIMUM RATING**

Stressing the device above the rating listed in the Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not im-

plied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

**Table 5. Absolute Maximum Ratings** 

| Symbol                            | Parameter                                 | Value                        | Unit |
|-----------------------------------|-------------------------------------------|------------------------------|------|
| T <sub>STG</sub>                  | Storage Temperature (V <sub>CC</sub> Off) | -55 to 150                   | °C   |
| T <sub>SLD</sub> <sup>(1)</sup>   | Lead Solder Temperature for 10 seconds    | 260                          | °C   |
| V <sub>IO</sub>                   | Input or Output Voltage                   | -0.3 to V <sub>CC</sub> +0.3 | V    |
| V <sub>CC</sub> /V <sub>BAT</sub> | Supply Voltage                            | -0.3 to 6.0                  | V    |
| lo                                | Output Current                            | 20                           | mA   |
| P <sub>D</sub>                    | Power Dissipation                         | 320                          | mW   |

Note: 1. Reflow at peak temperature of 255°C to 260°C for < 30 seconds (total thermal budget not to exceed 180°C for between 90 to 150 seconds).

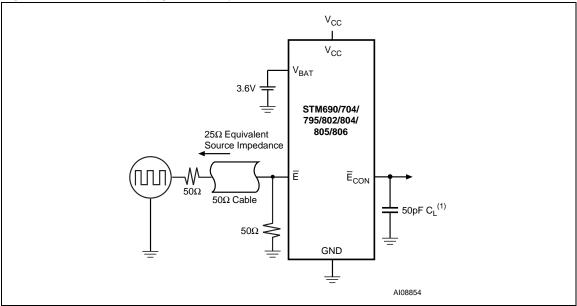
## DC AND AC PARAMETERS

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow, are derived from tests performed under the Measurement Conditions summarized in Table 6, Operating and AC Measurement Conditions. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

**Table 6. Operating and AC Measurement Conditions** 

| Parameter                                        | STM690/704/795/<br>802/804/805/806 | Unit |
|--------------------------------------------------|------------------------------------|------|
| V <sub>CC</sub> /V <sub>BAT</sub> Supply Voltage | 1.0 to 5.5                         | V    |
| Ambient Operating Temperature (T <sub>A</sub> )  | -40 to 85                          | °C   |
| Input Rise and Fall Times                        | ≤ 5                                | ns   |
| Input Pulse Voltages                             | 0.2 to 0.8V <sub>CC</sub>          | V    |
| Input and Output Timing Ref. Voltages            | 0.3 to 0.7V <sub>CC</sub>          | V    |

Figure 34.  $\overline{E}$  to  $\overline{E}_{CON}$  Propagation Delay Test Circuit



Note: 1. C<sub>L</sub> includes load capacitance and scope probe capacitance.

Figure 35. AC Testing Input/Output Waveforms

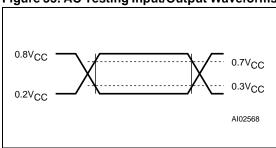
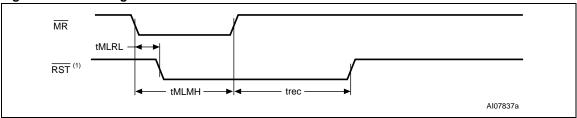


Figure 36. MR Timing Waveform



Note: 1. RST for STM805.

Figure 37. Watchdog Timing



**Table 7. DC and AC Characteristics** 

| Sym                                                  | Alter-<br>native    | Description                                               | Test Condition <sup>(1)</sup>                                                    | Min                      | Тур                       | Max                | Unit |
|------------------------------------------------------|---------------------|-----------------------------------------------------------|----------------------------------------------------------------------------------|--------------------------|---------------------------|--------------------|------|
| V <sub>CC</sub> ,<br>V <sub>BAT</sub> <sup>(2)</sup> |                     | Operating Voltage                                         | $T_A = -40 \text{ to } +85^{\circ}\text{C}$                                      | 1.1 <sup>(3)</sup>       |                           | 5.5                | ٧    |
|                                                      |                     | V <sub>CC</sub> Supply Current                            | Excluding I <sub>OUT</sub> (V <sub>CC</sub> < 5.5V)                              |                          | 40                        | 60                 | μΑ   |
|                                                      |                     | VCC Supply Current                                        | Excluding I <sub>OUT</sub> (V <sub>CC</sub> < 3.6V)                              |                          | 35                        | 50                 | μΑ   |
| I <sub>CC</sub>                                      |                     | V <sub>CC</sub> Supply Current in<br>Battery Back-up Mode | Excluding $I_{OUT}$<br>$(V_{BAT} = 2.3V, V_{CC} = 2.0V, \overline{MR} = V_{CC})$ |                          | 25                        | 35                 | μA   |
| I <sub>BAT</sub> <sup>(4)</sup>                      |                     | V <sub>BAT</sub> Supply Current in Battery Back-up Mode   | Excluding I <sub>OUT</sub><br>(V <sub>BAT</sub> = 3.6V)                          |                          | 0.4                       | 1.0                | μA   |
|                                                      |                     |                                                           | I <sub>OUT1</sub> = 5mA <sup>(5)</sup>                                           | V <sub>CC</sub> – 0.03   | V <sub>CC</sub> – 0.015   |                    | ٧    |
| V <sub>OUT1</sub>                                    |                     | V <sub>OUT</sub> Voltage (Active)                         | I <sub>OUT1</sub> = 75mA                                                         | V <sub>CC</sub> - 0.3    | V <sub>CC</sub> –<br>0.15 |                    | V    |
|                                                      |                     |                                                           | $I_{OUT1} = 250\mu A,$<br>$V_{CC} > 2.5V^{(5)}$                                  | V <sub>CC</sub> – 0.0015 | V <sub>CC</sub> - 0.0006  |                    | ٧    |
| V <sub>OUT2</sub>                                    |                     | V <sub>OUT</sub> Voltage (Battery                         | I <sub>OUT2</sub> = 250μA, V <sub>BAT</sub> = 2.3V                               | V <sub>BAT</sub> – 0.1   | V <sub>BAT</sub> – 0.034  |                    | V    |
| VOU12                                                |                     | Back-up)                                                  | $I_{OUT2} = 1$ mA, $V_{BAT} = 2.3$ V                                             |                          | V <sub>BAT</sub> – 0.14   |                    | ٧    |
|                                                      | V <sub>CC</sub> to  | V <sub>OUT</sub> On-resistance                            |                                                                                  |                          | 3                         | 4                  | Ω    |
|                                                      | V <sub>BAT</sub> to | V <sub>OUT</sub> On-resistance                            |                                                                                  |                          | 100                       |                    | Ω    |
|                                                      |                     | Input Leakage Current (MR)                                | STM704/806 only;<br>MR = 0V; V <sub>CC</sub> = 3V                                | 20                       | 75                        | 350                | μA   |
| ILI                                                  |                     | Input Leakage Current (PFI)                               | $0V = V_{IN} = V_{CC}$                                                           | -25                      | 2                         | +25                | nA   |
|                                                      |                     | Input Leakage Current (WDI)                               | $0V = V_{IN} = V_{CC}$                                                           | -1                       |                           | +1                 | μΑ   |
| I <sub>LO</sub>                                      |                     | Output Leakage Current                                    | STM804/805/795;<br>$0V = V_{IN} = V_{CC}^{(6)}$                                  | -1                       |                           | +1                 | μA   |
| $V_{IH}$                                             |                     | Input High Voltage (MR, WDI)                              | V <sub>RST</sub> (max) < V <sub>CC</sub> < 5.5V                                  | 0.7V <sub>CC</sub>       |                           |                    | V    |
| $V_{IL}$                                             |                     | Input Low Voltage (MR, WDI)                               | V <sub>RST</sub> (max) < V <sub>CC</sub> < 5.5V                                  |                          |                           | 0.3V <sub>CC</sub> | V    |

## STM690/704/795/802/804/805/806

| Sym              | Alter-<br>native | Description                                                          | Test Condition <sup>(1)</sup>                                           |                                                             | Min                 | Тур             | Max                | Unit     |
|------------------|------------------|----------------------------------------------------------------------|-------------------------------------------------------------------------|-------------------------------------------------------------|---------------------|-----------------|--------------------|----------|
| Voi              |                  | Output Low Voltage (PFO, RST, RST, Vccsw)                            |                                                                         | sst (max),<br>3.2mA                                         |                     |                 | 0.3                | ٧        |
| V <sub>OL</sub>  |                  | Output Low Voltage (Econ)                                            |                                                                         | nA, E = 0V                                                  |                     |                 | 0.2V <sub>CC</sub> | ٧        |
| V <sub>OL</sub>  |                  | Output Low Voltage (RST)                                             | V <sub>BAT</sub> :                                                      | V <sub>CC</sub> = 1.0V;<br>= V <sub>CC</sub> ;<br>C to 85°C |                     |                 | 0.3                | ٧        |
|                  |                  |                                                                      |                                                                         | 200µA;<br>V <sub>BAT</sub> = V <sub>CC</sub>                |                     |                 | 0.3                | V        |
|                  |                  | Output High Voltage (RST, RST) <sup>(7)</sup>                        |                                                                         | = 1mA,<br>RST (max)                                         | 2.4                 |                 |                    | V        |
| V <sub>OH</sub>  |                  | Output High Voltage (E <sub>CON</sub> )                              |                                                                         | <sub>RST</sub> (max),<br>nA, <del>E</del> = V <sub>CC</sub> | 0.8V <sub>CC</sub>  |                 |                    | ٧        |
|                  |                  | Output High Voltage (PFO)                                            | I <sub>SOURCE</sub> = 75µA,<br>V <sub>CC</sub> = V <sub>RST</sub> (max) |                                                             | 0.8V <sub>CC</sub>  |                 |                    | ٧        |
| V <sub>OHB</sub> |                  | V <sub>OH</sub> Battery Back-up ( $\overline{E}_{CON}$ , Vccsw, RST) | I <sub>SOURCE</sub> = 100μA,                                            |                                                             | 0.8V <sub>BAT</sub> |                 |                    | ٧        |
| Power-fa         | il Comp          | arator (NOT available on STM                                         | 795)                                                                    |                                                             |                     |                 |                    |          |
| V <sub>PFI</sub> |                  | PFI Input Threshold                                                  | PFI Falling                                                             | STM802/<br>804/806                                          | 1.212               | 1.237           | 1.262              | <b>V</b> |
| VPFI             |                  | 1 1 1 mput Tillesiloid                                               | (V <sub>CC</sub> < 3.6V)                                                | STM690/<br>704/805                                          | 1.187               | 1.237           | 1.287              | ٧        |
|                  |                  | PFI Hysteresis                                                       | PFI Rising (                                                            | $V_{CC} < 3.6V$                                             |                     | 10              | 20                 | mV       |
| t <sub>PFD</sub> |                  | PFI to PFO Propagation Delay                                         |                                                                         |                                                             |                     | 2               |                    | μs       |
| I <sub>SC</sub>  |                  | PFO Output Short to<br>GND Current                                   | V <sub>CC</sub> = 3.6\                                                  | /, PFO = 0V                                                 | 0.1                 | 0.75            | 2.0                | mA       |
| Battery \$       | Switchov         | /er                                                                  |                                                                         |                                                             |                     |                 |                    |          |
|                  |                  |                                                                      | Dower days                                                              | V <sub>BAT</sub> > V <sub>SW</sub>                          |                     | $V_{SW}$        |                    | V        |
|                  |                  | Battery Back-up                                                      | Power-down                                                              | V <sub>BAT</sub> < V <sub>SW</sub>                          |                     | $V_{BAT}$       |                    | V        |
| Vso              |                  | Switchover Voltage (8,9)                                             | Power up                                                                | V <sub>BAT</sub> > V <sub>SW</sub>                          |                     | $V_{\text{SW}}$ |                    | V        |
| VSO              |                  |                                                                      | Power-up                                                                | V <sub>BAT</sub> < V <sub>SW</sub>                          |                     | $V_{BAT}$       |                    | V        |
|                  |                  | V <sub>SW</sub>                                                      | 1                                                                       |                                                             |                     | 2.4             |                    | V        |
|                  |                  | Hysteresis                                                           |                                                                         |                                                             |                     | 40              |                    | mV       |

| Sym                                     | Alter-<br>native | Description                    | Test Condition <sup>(1)</sup>                                |                          | Min  | Тур   | Max  | Unit |
|-----------------------------------------|------------------|--------------------------------|--------------------------------------------------------------|--------------------------|------|-------|------|------|
| Reset Th                                | reshold          | s                              |                                                              |                          |      |       |      | •    |
|                                         |                  |                                | STM690T/                                                     | V <sub>CC</sub> Falling  | 3.00 | 3.075 | 3.15 | V    |
|                                         |                  |                                | 704T/795T/<br>805T                                           | V <sub>CC</sub> Rising   | 3.00 | 3.085 | 3.17 | V    |
|                                         |                  |                                | STM802T/                                                     | V <sub>CC</sub> Falling  | 3.00 | 3.075 | 3.12 | V    |
|                                         |                  |                                | 804T/806T                                                    | V <sub>CC</sub> Rising   | 3.00 | 3.085 | 3.14 | V    |
|                                         |                  |                                | STM690S/                                                     | V <sub>CC</sub> Falling  | 2.85 | 2.925 | 3.00 | V    |
| v (10)                                  |                  | Reset Threshold                | 704S/795S/<br>805S                                           | V <sub>CC</sub> Rising   | 2.85 | 2.935 | 3.02 | V    |
| V <sub>RST</sub> <sup>(10)</sup>        |                  | Reset Tillesiloid              | STM802S/                                                     | V <sub>CC</sub> Falling  | 2.88 | 2.925 | 3.00 | V    |
|                                         |                  |                                | 804S/806S                                                    | V <sub>CC</sub> Rising   | 2.88 | 2.935 | 3.02 | V    |
|                                         |                  |                                | STM690R/                                                     | V <sub>CC</sub> Falling  | 2.55 | 2.625 | 2.70 | V    |
|                                         |                  |                                | 704R/795R/<br>805R                                           | V <sub>CC</sub> Rising   | 2.55 | 2.635 | 2.72 | V    |
|                                         |                  |                                | STM802R/                                                     | V <sub>CC</sub> Falling  | 2.59 | 2.625 | 2.70 | V    |
|                                         |                  |                                | 804R/806R                                                    | V <sub>CC</sub> Rising   | 2.59 | 2.635 | 2.72 | V    |
| t <sub>rec</sub>                        |                  | RST Pulse Width                | V <sub>CC</sub> <                                            | < 3.6V                   | 140  | 200   | 280  | ms   |
| Push-but                                | tton Res         | et Input (STM704/806)          | •                                                            | •                        |      |       |      |      |
| t <sub>MLMH</sub>                       | t <sub>MR</sub>  | MR Pulse Width                 |                                                              |                          | 100  | 20    |      | ns   |
| t <sub>MLRL</sub>                       | t <sub>MRD</sub> | MR to RST Output Delay         |                                                              |                          |      | 60    | 500  | ns   |
| Watchdo                                 | g Timer          | (NOT available on STM704/79    | 5/806)                                                       | •                        |      |       |      |      |
| t <sub>WD</sub>                         |                  | Watchdog Timeout Period        | V <sub>RST</sub> (max) < V <sub>CC</sub> < 3.6V              |                          | 1.12 | 1.60  | 2.24 | S    |
|                                         |                  | WDI Pulse Width                | V <sub>RST</sub> (max) ·                                     | < V <sub>CC</sub> < 3.6V | 100  | 20    |      | ns   |
| Chip-Ena                                | able Gati        | ing (STM795 only)              |                                                              |                          |      |       |      |      |
| E-to-E <sub>CON</sub> Resistance        |                  | $V_{CC} = V_F$                 | RST (max)                                                    |                          | 46   |       | Ω    |      |
| Ē-to-Ē <sub>CON</sub> Propagation Delay |                  | $V_{CC} = V_F$                 | RST (max)                                                    |                          | 2    | 7     | ns   |      |
|                                         | Reset-           | to-E <sub>CON</sub> High Delay |                                                              |                          |      | 10    |      | μs   |
| I <sub>SC</sub>                         | Ē                | CON Short Circuit Current      | $V_{CC} = 3.6V$ , Disable Mode,<br>$\overline{E}_{CON} = 0V$ |                          | 0.1  | 0.75  | 2.0  | mA   |

- 5. Guaranteed by design.
- 6. The leakage current measured on the RST pin (STM804/805) or RST pin (STM795) is tested with the reset output not asserted (output high impedance).
- 7. Not valid for STM795/804/805 (open drain).

- When V<sub>BAT</sub> > V<sub>CC</sub> > V<sub>SW</sub>, V<sub>OUT</sub> remains connected to V<sub>CC</sub> until V<sub>CC</sub> drops below V<sub>SW</sub>.
   When V<sub>SW</sub> > V<sub>CC</sub> > V<sub>BAT</sub>, V<sub>OUT</sub> remains connected to V<sub>CC</sub> until V<sub>CC</sub> drops below the battery voltage (V<sub>BAT</sub>) 75mV.
   The reset threshold tolerance is wider for V<sub>CC</sub> rising than for V<sub>CC</sub> falling due to the 10mV (typ) hysteresis, which prevents internal oscillation.

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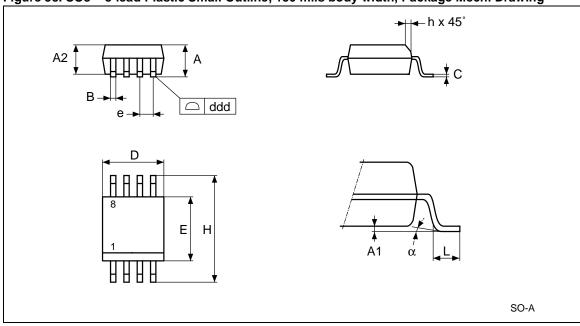
Note: 1. Valid for Ambient Operating Temperature:  $T_A = -40$  to  $85^{\circ}$ C;  $V_{CC} = V_{RST}$  (max) to 5.5V; and  $V_{BAT} = 2.8V$  (except where noted). 2.  $V_{CC}$  supply current, logic input leakage, Watchdog functionality, Push-button Reset functionality, PFI functionality, state of  $\overline{RST}$  and RST tested at  $V_{BAT} = 3.6V$ , and  $V_{CC} = 5.5V$ . The state of  $\overline{RST}$  or RST and  $\overline{PFO}$  is tested at  $V_{CC} = V_{CC}$  (min). Either  $V_{CC}$  or  $V_{BAT}$ can go to 0V if the other is greater than 2.0V.

3. V<sub>CC</sub> (min) = 1.0V for T<sub>A</sub> = 0°C to +85°C.

4. Tested at V<sub>BAT</sub> = 3.6V, V<sub>CC</sub> = 3.5V and 0V.

## **PACKAGE MECHANICAL**

Figure 38. SO8 – 8-lead Plastic Small Outline, 150 mils body width, Package Mech. Drawing



Note: Drawing is not to scale.

Table 8. SO8 – 8-lead Plastic Small Outline, 150 mils body width, Package Mechanical Data

| Symb   |      | mm   |      | inches |       |       |  |
|--------|------|------|------|--------|-------|-------|--|
| Syllib | Тур  | Min  | Max  | Тур    | Min   | Max   |  |
| Α      | -    | 1.35 | 1.75 | -      | 0.053 | 0.069 |  |
| A1     | -    | 0.10 | 0.25 | =      | 0.004 | 0.010 |  |
| В      | -    | 0.33 | 0.51 | -      | 0.013 | 0.020 |  |
| С      | -    | 0.19 | 0.25 | =      | 0.007 | 0.010 |  |
| D      | -    | 4.80 | 5.00 | =      | 0.189 | 0.197 |  |
| ddd    | -    | -    | 0.10 | _      | -     | 0.004 |  |
| E      | -    | 3.80 | 4.00 | -      | 0.150 | 0.157 |  |
| е      | 1.27 | -    | -    | 0.050  | -     | -     |  |
| Н      | -    | 5.80 | 6.20 | _      | 0.228 | 0.244 |  |
| h      | -    | 0.25 | 0.50 | -      | 0.010 | 0.020 |  |
| L      | _    | 0.40 | 0.90 | -      | 0.016 | 0.035 |  |
| α      | -    | 0°   | 8°   | -      | 0°    | 8°    |  |
| N      |      | 8    |      | 8      |       |       |  |

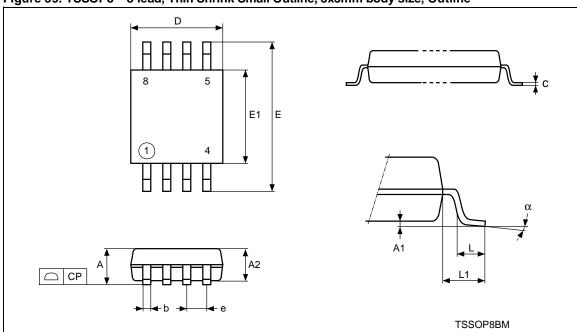


Figure 39. TSSOP8 – 8-lead, Thin Shrink Small Outline, 3x3mm body size, Outline

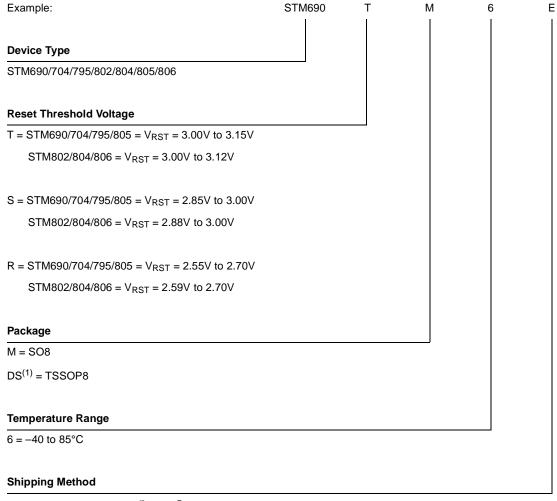
Note: Drawing is not to scale.

Table 9. TSSOP8 – 8-lead, Thin Shrink Small Outline, 3x3mm body size, Mechanical Data

| Symb | mm   |      |      | inches |       |       |
|------|------|------|------|--------|-------|-------|
|      | Тур  | Min  | Max  | Тур    | Min   | Max   |
| Α    | _    | -    | 1.10 | _      | -     | 0.043 |
| A1   | -    | 0.05 | 0.15 | _      | 0.002 | 0.006 |
| A2   | 0.85 | 0.75 | 0.95 | 0.034  | 0.030 | 0.037 |
| b    | -    | 0.25 | 0.40 | -      | 0.010 | 0.016 |
| С    | _    | 0.13 | 0.23 | -      | 0.005 | 0.009 |
| СР   | _    | -    | 0.10 | -      | -     | 0.004 |
| D    | 3.00 | 2.90 | 3.10 | 0.118  | 0.114 | 0.122 |
| е    | 0.65 | -    | _    | 0.026  | -     | -     |
| E    | 4.90 | 4.65 | 5.15 | 0.193  | 0.183 | 0.203 |
| E1   | 3.00 | 2.90 | 3.10 | 0.118  | 0.114 | 0.122 |
| L    | 0.55 | 0.40 | 0.70 | 0.022  | 0.016 | 0.030 |
| L1   | 0.95 | -    | -    | 0.037  | -     | -     |
| α    | _    | 0°   | 6°   | _      | 0°    | 6°    |
| N    | 8    |      |      | 8      |       |       |

## **PART NUMBERING**





E = Tubes (Pb-Free - ECO PACK®)

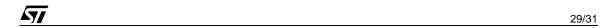
F = Tape & Reel (Pb-Free - ECO PACK®)

Note: 1. Contact local ST sales office for availability.

For other options, or for more information on any aspect of this device, please contact the ST Sales Office nearest you.

**Table 11. Marking Description** 

| Part Number | Reset Threshold | Package | Topside Marking |  |
|-------------|-----------------|---------|-----------------|--|
| STM690T     | 3.075           | SO8     | 690T            |  |
| 311/10901   | 3.075           | TSSOP8  | — 690T          |  |
| STM690S     | 2.925           | SO8     | 690S            |  |
| 3110903     | 2.925           | TSSOP8  | 0903            |  |
| CTMCOOD     | 2.625           | SO8     | 690R            |  |
| STM690R     | 2.625           | TSSOP8  | 090K            |  |
| STM704T     | 2.075           | SO8     | 704T            |  |
| 3111/1/041  | 3.075           | TSSOP8  | 7041            |  |
| CTM704C     | 2.925           | SO8     | 7040            |  |
| STM704S     |                 | TSSOP8  | 704S            |  |
| OTM704D     | 2.625           | SO8     | 704R            |  |
| STM704R     |                 | TSSOP8  |                 |  |
| OT1 4705T   | 0.075           | SO8     | 7057            |  |
| STM795T     | 3.075           | TSSOP8  | — 795T          |  |
| 07147070    | 2.22            | SO8     |                 |  |
| STM795S     | 2.925           | TSSOP8  | 795S            |  |
|             |                 | SO8     |                 |  |
| STM795R     | 2.625           | TSSOP8  | 795R            |  |
|             |                 | SO8     | 802T            |  |
| STM802T     | 3.075           | TSSOP8  |                 |  |
|             |                 | SO8     | 802S            |  |
| STM802S     | 2.925           | TSSOP8  |                 |  |
|             | 2.625           | SO8     | 802R            |  |
| STM802R     |                 | TSSOP8  |                 |  |
|             | 3.075           | SO8     | 804T            |  |
| STM804T     |                 | TSSOP8  |                 |  |
|             | 2.925           | SO8     | 804S            |  |
| STM804S     |                 | TSSOP8  |                 |  |
|             |                 | SO8     |                 |  |
| STM804R     | 2.625           | TSSOP8  | 804R            |  |
|             |                 | SO8     |                 |  |
| STM805T     | 3.075           | TSSOP8  | 805T            |  |
|             |                 | SO8     |                 |  |
| STM805S     | 2.925           | TSSOP8  | 805S            |  |
|             |                 | SO8     |                 |  |
| STM805R     | 2.625           | TSSOP8  | 805R            |  |
|             |                 | SO8     |                 |  |
| STM806T     | 3.075           | TSSOP8  | 806T            |  |
|             |                 | SO8     | 806S            |  |
| STM806S     | 2.925           | TSSOP8  |                 |  |
|             |                 | SO8     | 806R            |  |
| STM806R     | 2.625           | TSSOP8  |                 |  |



# **REVISION HISTORY**

**Table 12. Document Revision History** 

| Date             | Version | Revision Details                                                                                                                              |  |
|------------------|---------|-----------------------------------------------------------------------------------------------------------------------------------------------|--|
| October 31, 2003 | 1.0     | First Issue                                                                                                                                   |  |
| 22-Dec-03        | 2.0     | Reformatted; update characteristics (Figure 1, 3, 4, 11, 13, 14, 36; Table 1, 3, 4, 7, 9, 11)                                                 |  |
| 16-Jan-04        | 2.1     | Add Typical Operating Characteristics (Figure 16, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, 30, 31, 32, 33)                         |  |
| 07-Apr-04        | 2.2     | Update characteristics (Figure 13, 25, 26, 27, 28, 31; Table 1, 3, 7)                                                                         |  |
| 25-May-04        | 3.0     | Update characteristics (Table 3, 7)                                                                                                           |  |
| 02-Jul-04        | 4.0     | Update package availability, pin description; promote document (Figure 1, 14; Table 3, 10)                                                    |  |
| 29-Sep-04        | 5.0     | Clarify root part numbers, pin descriptions, update characteristics (Figure 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 13, 14, 34; Table 1, 3, 6, 7, 10) |  |

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